



**SF2038C**

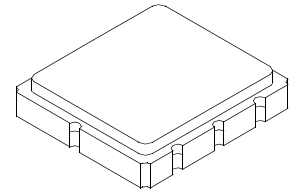
**76.500 MHz  
SAW Filter**

- *Designed for SDARS IF Receiver*
- *Low Insertion Loss*
- *5.0 x 5.0 mm Surface-mount Case*
- *Differential or Single-ended Input and Output*
- *Complies with Directive 2002/95/EC (RoHS)*



**Absolute Maximum Ratings**

Rating	Value	Units
Maximum Incident Power in Passband	+10	dBm
Maximum DC Voltage on any Non-ground Terminal	30	VDC
Storage Temperature Range in Tape and Reel	-40 to +85	°C
Maximum Soldering Profile	265°C for 10 s	



**SM5050-8**

**Electrical Characteristics**

Characteristic	Sym	Notes	Min	Typ	Max	Units
Nominal Center Frequency	$f_C$	1		76.500		MHz
Passband Insertion Loss	IL			10.8	12.0	dB
1 dB Bandwidth	$BW_1$		12.0	12.7		MHz
15 dB Bandwidth	$BW_{15}$			17.5	18.0	MHz
30 dB Bandwidth	$BW_{30}$	1		19.4	20.0	MHz
Amplitude Ripple over $f_c \pm 6.0$ MHz				0.60	1.3	dB <sub>p-p</sub>
Group Delay Variation over $f_c \pm 6.0$ MHz	GDV			40	150	ns <sub>p-p</sub>
Rejection:						
50 to 64.44 MHz		1, 3	36	42		dB
64.44 to 66.70 MHz			33	39		
86.30 to 87.06 MHz			16*	24		
87.06 to 91.50 MHz			23*	34		
91.50 to 100.000 MHz			36	40		
Operating Temperature Range	$T_A$	1	-40		+85	°C
Frequency Temperature Coefficient	FTC			-87		ppm/°C
Differential Input				175 ohms		
Differential Output				180 ohms		
Case Style				SM5050-8 5 x 5 mm Nominal Footprint		
Lid Symbolization (Y=year, WW=week, S=shift) See note 4		6		RFM 913 YWWS		

\*At low temperature extreme -40 °C

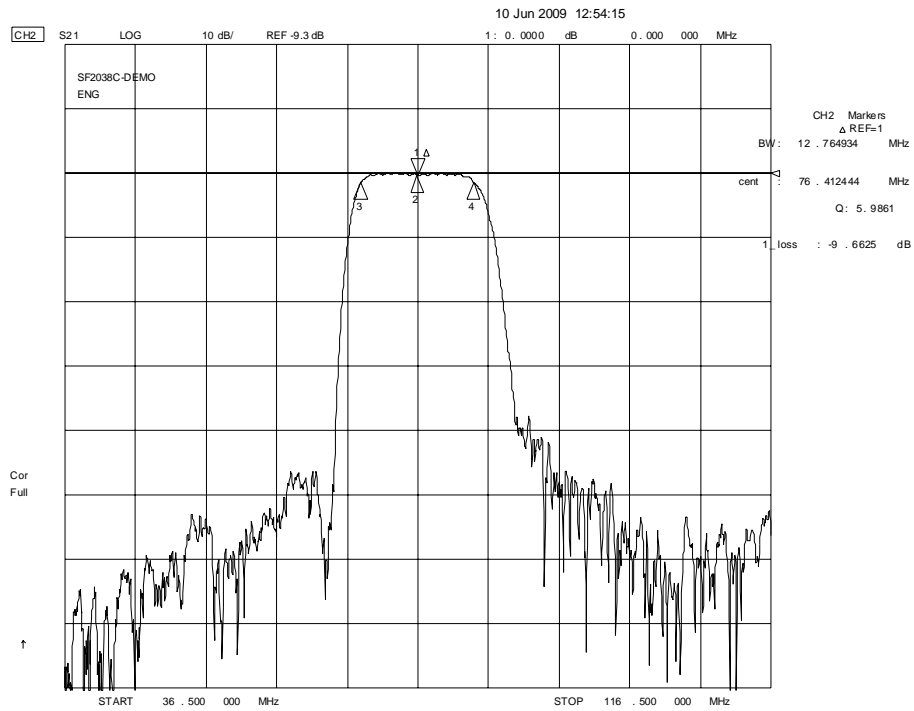


**CAUTION: Electrostatic Sensitive Device. Observe precautions for handling.**

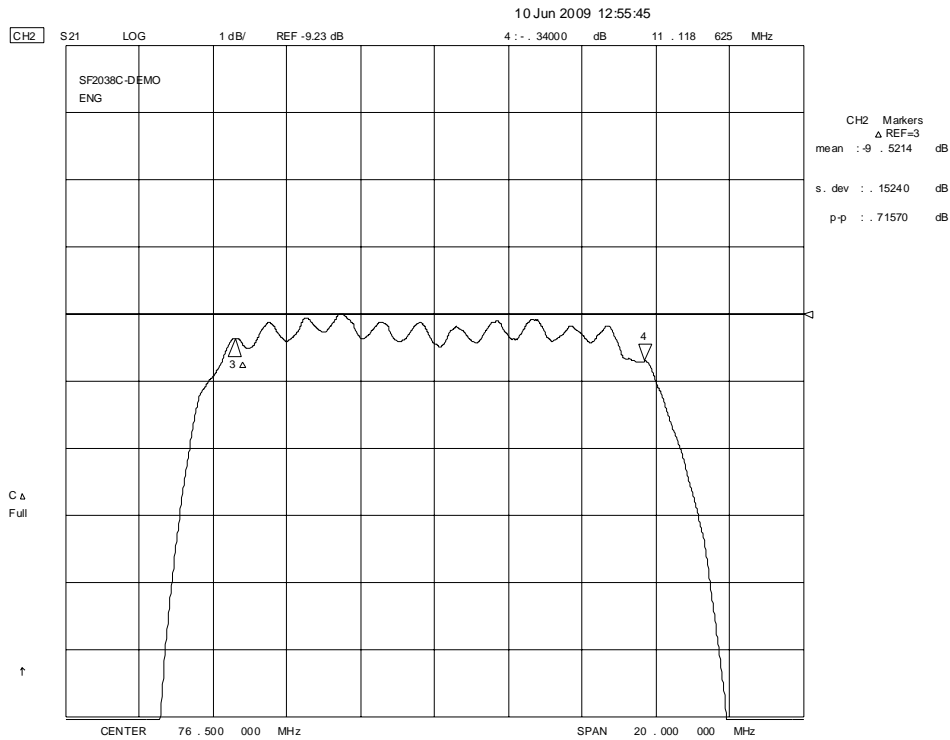
**Notes:**

1. Unless noted otherwise, all specifications apply over the operating temperature range with filter soldered to the specified demonstration board with impedance matching to 50  $\Omega$  and measured with 50  $\Omega$  network analyzer.
2. Unless noted otherwise, all frequency specifications are referenced to the nominal center frequency,  $f_c$ .
3. Rejection is measured as attenuation below the minimum IL point in the passband. Rejection in final user application is dependent on PCB layout and external impedance matching design. See Application Note No. 42 for details.
4. "LRIP" or "L" after the part number indicates "low rate initial production" and "ENG" or "E" indicates "engineering prototypes."
5. The design, manufacturing process, and specifications of this filter are subject to change.
6. Tape and Reel Standard ANSI / EIA 481.
7. Either Port 1 or Port 2 may be used for either input or output in the design. However, impedances and impedance matching may vary between Port 1 and Port 2, so that the filter must always be installed in one direction per the circuit design.
8. US and international patents may apply.
9. RFM, stylized RFM logo, and RF Monolithics, Inc. are registered trademarks of RF Monolithics, Inc.

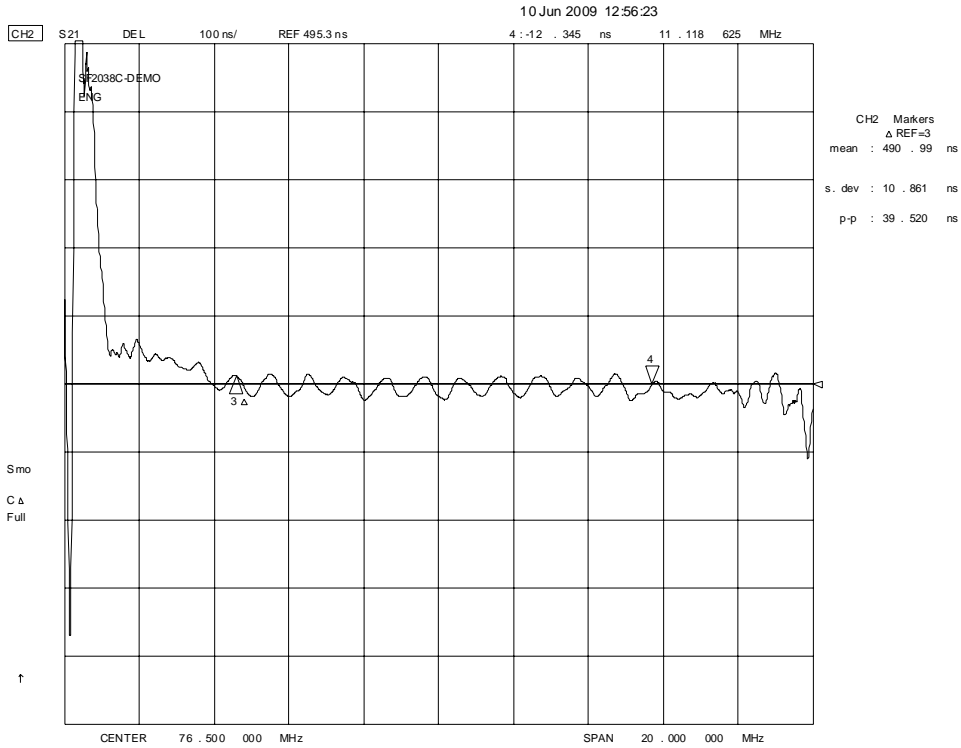
# Filter Response, 36.5 to 116.5 MHz



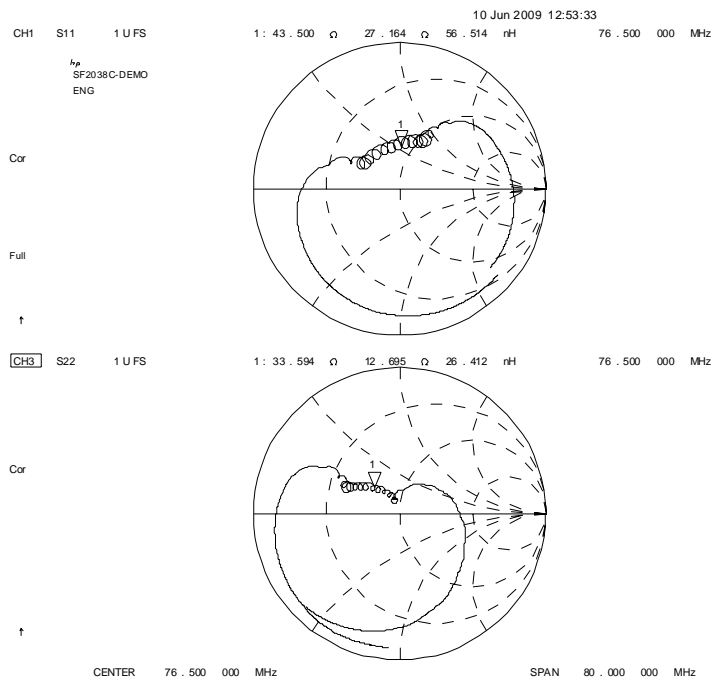
# Filter Passband Response



# Filter Passband Group Delay Response

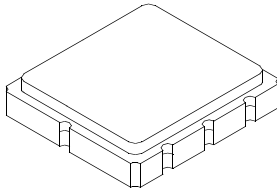


# Filter $S_{11}$ and $S_{22}$ Plots



# SM5050-8 Surface-Mount 8-Terminal Ceramic Case

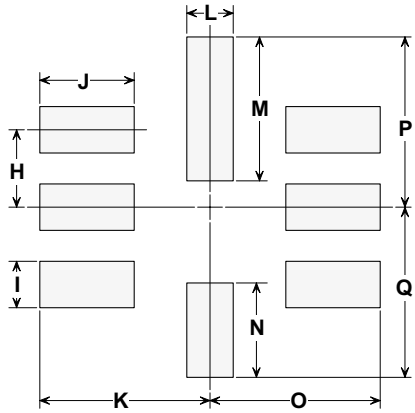
## 5.0 X 5.0 mm Nominal Footprint



### Case Dimensions

Dimension	mm			Inches		
	Min	Nom	Max	Min	Nom	Max
A	4.80	5.00	5.20	0.189	0.197	0.205
B	4.80	5.00	5.20	0.189	0.197	0.205
C	1.30	1.50	1.70	0.050	0.060	0.067
D	1.98	2.08	2.18	0.078	0.082	0.086
E	1.07	1.17	1.27	0.042	0.046	0.050
F	0.50	0.64	0.70	0.020	0.025	0.028
G	2.39	2.54	2.69	0.094	0.100	0.106
H		1.27			0.050	
I		0.76			0.030	
J		1.55			0.061	
K		2.79			0.110	
L		0.76			0.030	
M		2.36			0.093	
N		1.55			0.061	
O		2.79			0.110	
P		2.79			0.110	
Q		2.79			0.110	

### PCB Footprint



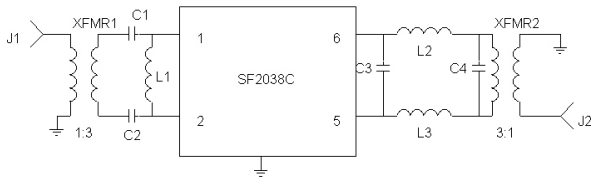
### Case Materials

Materials	
Solder Pad Plating	0.3 to 1.0 $\mu\text{m}$ Gold over 1.27 to 8.89 $\mu\text{m}$ Nickel
Lid Plating	2.0 to 3.0 $\mu\text{m}$ Nickel
Body	$\text{Al}_2\text{O}_3$ Ceramic
	Pb Free

### Electrical Connections

Connection	Terminals
Port 1	Differential Input 1, 2
Port 2	Differential Output 5, 6
	Ground All others
Single-ended Operation	Return is ground
Differential Operation	Return is hot
Dot indicates Pin 1	

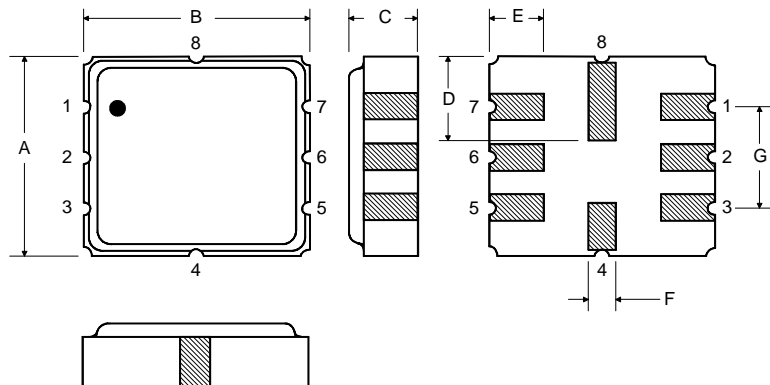
### Test Circuit



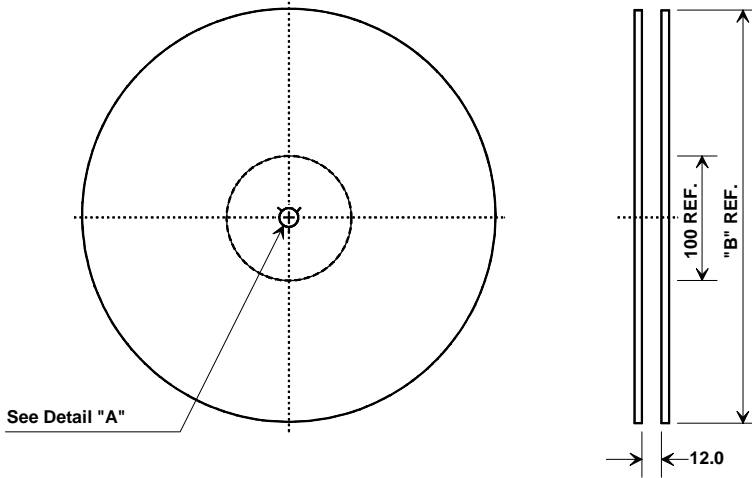
- L1                    330 nH
- L2, L3                270 nH
- C1, C4                18 pF
- C2                    15 pF
- C3                    1 pF
- XFMR1, XFMR 2 3:1
- XFMR1, XFMR 2 3:1

### TOP VIEW

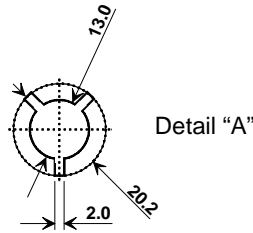
### BOTTOM VIEW



# Tape and Reel Specifications



"B" Nominal Size		Quantity Per Reel
Inches	millimeters	
7	178	500
13	330	3000



## COMPONENT ORIENTATION and DIMENSIONS

Carrier Tape Dimensions	
Ao	5.3 mm
Bo	5.3 mm
Ko	2.0 mm
Pitch	8.0 mm
W	12.0 mm

